PATENT ASSIGNMENT

Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE: NEW ASSIGNMENT

NATURE OF CONVEYANCE: ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Teruaki CHINO	02/05/2010

RECEIVING PARTY DATA

Name:	SHINKO ELECTRIC INDUSTRIES CO., LTD.
Street Address:	80, Oshimada-machi
City:	Nagano-shi, Nagano
State/Country:	JAPAN
Postal Code:	381-2287

PROPERTY NUMBERS Total: 1

Property Type	Number	
Application Number:	12702705	

CORRESPONDENCE DATA

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NAME OF SUBMITTER: Mercedes K. Meyer, Ph.D., Esq.

Total Attachments: 1

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OP \$40.00 127

PATENT REEL: 023917 FRAME: 0070

ATTORNEY DOCKET NO.: SOLEJOINT INVENTION

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ASSIGNMENT

SEMICONDUCTOR DEVICE AND METHOD OF MANUFACTURING THE SAME, AND ELECTRONIC APPARATUS

WHEREAS I/We, the below named inventor(s), [hereinafter referred to as Assignor(s)], have made an invention entitled:

for which I/WE executed an application for Unitapplication for United States Letters Patent on _			
WHEREAS, Shinko Electric Industries address is 80, Oshimada-machi, Nagano-shi, Na Assignee), is desirous of securing the entire right application for United States Letters Patent on tapplication;	igano, 381-2287 Japan, (int, title, and interest in and	nereinafter refer I to this invention	red to as n, the
NOW THEREFORE, be it known that, from assignee is hereby acknowledged, I/WE, a and do hereby sell, assign, transfer, and set over MY/OUR entire right, title, and interest in and t continuations thereof, and all Letters Patent of t reissues thereof; and I/WE hereby authorize and the United States to issue all Letters Patent for t accordance with the terms of this Assignment;	s assignor(s), have sold, a runto the assignee, its law o this invention and this a he United States which m I request the Commission	ssigned, transfer ful successors at pplication, and a ay be granted the or of Patents and	red, and set over, nd assigns, all divisions, and ereon, and all Trademarks of
AND, I/WE HEREBY further covenant communicate with assignee, its successors and a invention and testify in any legal proceeding, signed deliver all papers that may be necessary or assignee, its successors and assigns, execute all all rightful oaths and generally do everything poand enforce proper patent protection for this invexpense incident to the execution of such paper.	assigns, any facts known to gn all lawful papers when desirable to perfect the title divisional, continuation, a assible to aid assignee, its tention in the United State	o ME/US respect called upon to do the to this invention and reissue applitudes successors and a s, it being under	ting this to so, execute on in said cations, make assigns, to obtain stood that any
AND, I/WE HEREBY authorize and re and Power of Attorney in this application, to ins) the filing date and application number of IN TESTIMONY WHEREOF, I/WE has	ert here in parenthesis (A f said application when k	pplication No nown.	l in the Declaration , filed
	Assignor's Signature		Date
Teruaki CHINO	Ternaki China		February 5, 2010
Address c/o Shinko Electric Industries Co., Ltd., 80, Oshimada-machi, Nagano-shi, Nagano, 381-2287 Japan			Citizenship Japan
	Assignor's Signature		Date
Address			Citizenship
Names of additional inventors attached Yes	⊠ No		1

RECORDED: 02/09/2010

PATENT REEL: 023917 FRAME: 0071